

Primax

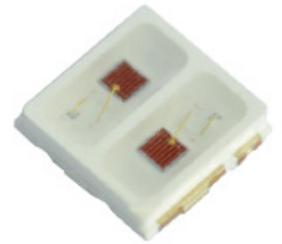
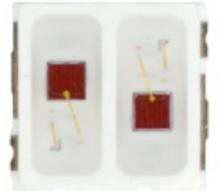
Synonymous with function and performance, enter the Primax, the new era of high intensity illumination in LED. With its high flux output and high luminous intensity, Primax transcends today LED lightings technology and how we perceive it. The small package outline and high intensity make it an ideal choice for backlighting, signage, exterior automotive lighting and decorative lighting.

Features:

- > Super high brightness surface mount LED
- > 120° viewing angle.
- > Compact package outline (LxW) of 3.7 x 3.5 mm.
- > Ultra low height profile - 0.8mm.
- > Low thermal resistance.
- > Compatible to IR reflow soldering.
- > Superior corrosion resistant.
- > Environmental friendly; RoHS compliance.
- > Compliance to automotive standard; AEC-Q102.

Applications:

- > Automotive: exterior applications, eg: signal lighting, Center High Mounted Stop Light (CHMSL), Rear Combination Lamp (RCL), Rear Fog Lamp.



Optical Characteristics at Tj=25°C

Part Number	Color, λdom (nm)		Viewing Angle°	Luminous Flux @ 350mA (lm) <small>Appx. 1.2</small>					
	Chip #1	Chip #2		Chip #1			Chip #2		
				Min.	Typ.	Max.	Min.	Typ.	Max.
MCSS-TZHG-QR3+QR3-3+3	Super Red, 635nm	Super Red, 635nm	120	30.6	39.8	51.7	30.6	39.8	51.7
MCSS-TZHG-Q3S2+Q3S2-2+2	Super Red, 630nm	Super Red, 630nm	120	34.8	45.2	59.0	34.8	45.2	59.0
MCAA-TZHG-RT2+RT2-4+4	Amber, 624nm	Amber, 624nm	120	39.8	59.0	76.5	39.8	59.0	76.5
MCAA-TZHG-SU2+SU2-2+2	Amber, 615nm	Amber, 615nm	120	51.7	67.2	99.4	51.7	67.2	99.4
MCAY-TZHG-RT2+Q3S-4+1	Amber, 624nm	Yellow, 587nm	120	39.8	59.0	76.5	34.8	45.0	67.2
MCAY-TZHG-SU2+Q3S-2+1	Amber, 615nm	Yellow 587nm	120	51.7	67.2	99.4	34.8	45.0	67.2

Electrical Characteristics at Tj=25°C

Part Number	Vf @ If = 350 mA <small>Appx. 3.1</small>		
	Min. (V)	Typ. (V)	Max. (V)
MCxx-TZHG	1.90	2.20	2.65

Absolute Maximum Ratings

	Maximum Value	Unit
DC forward current	400	mA
Peak pulse current (tp<=10µs , Duty cycle=0.10)	800	mA
Reverse Voltage	Not designed for reverse bias	V
ESD threshold (HBM)	8	kV
LED junction temperature	150	°C
Operating temperature	-40 ... +125	°C
Storage temperature	-40 ... +125	°C
Thermal resistance (Rated current = 350mA, Ts=25°C)		
- Real Thermal Resistance		
Junction / solder point, Rth JS real (Typ = 16K/W)	23	K/W
- Electrical Thermal Resistance		
Junction / solder point, Rth JS el (Typ = 12K/W)	17	K/W

Wavelength Grouping at Tj=25°C

Color	Group	Wavelength distribution (nm) <i>Appx. 2.2</i>
Super Red	Full	627 - 637
	W	627 - 630
	X	630 - 634
	Y	634 - 637
Amber	Full	612 - 627
	W	612 - 616
	X	616 - 620
	Y	620 - 624
	Z	624 - 627
Yellow	Full	586 - 595
	X	586 - 589
	Y	589 - 592
	Z	592 - 595

Luminous Flux at Tj=25°C

Brightness Group	Luminous Flux @ If=350mA (lm) <i>Appx. 1.2</i>
Q2	30.6 ... 34.8
Q3	34.8 ... 39.8
R2	39.8 ... 45.2
R3	45.2 ... 51.7
S2	51.7 ... 59.0
S3	59.0 ... 67.2
T2	67.2 ... 76.5
T3	76.5 ... 87.4
U2	87.4 ... 99.4

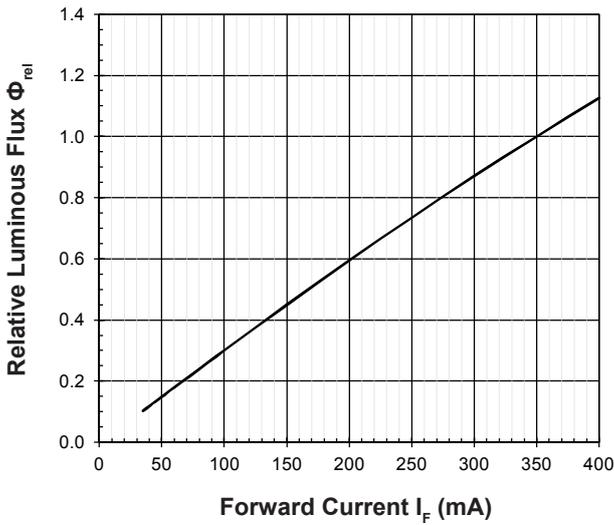
Vf Binning (Optional)

Vf Bin @ 350mA	Forward Voltage (V) <i>Appx. 3.1</i>
43	1.90 ... 2.05
44	2.05 ... 2.20
45	2.20 ... 2.35
46	2.35 ... 2.50
47	2.50 ... 2.65

Please consult sales and marketing for special part number to incorporate Vf binning.

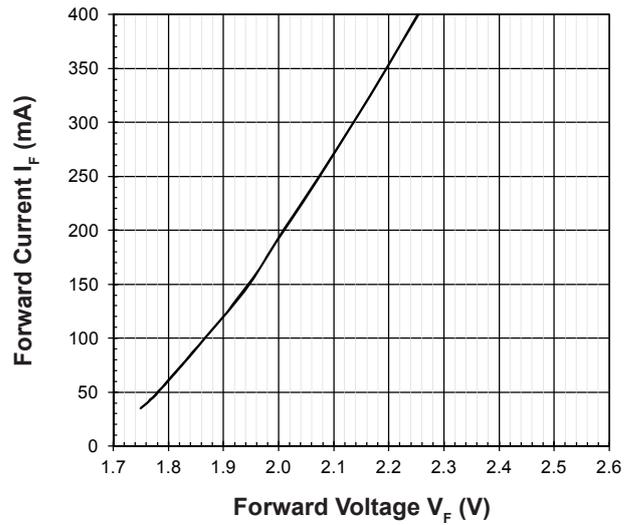
Relative Luminous Flux Vs Forward Current

$\Phi_V/\Phi_V(350\text{mA}) = f(I_F); T_j = 25^\circ\text{C}$



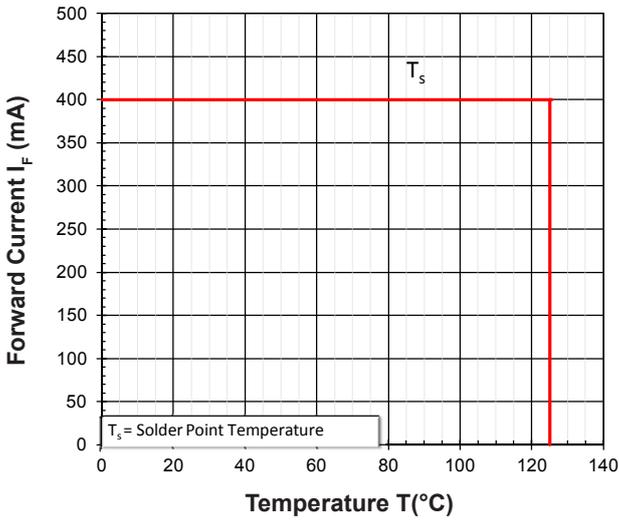
Forward Current Vs Forward Voltage

$I_F = f(V_F); T_j = 25^\circ\text{C}$



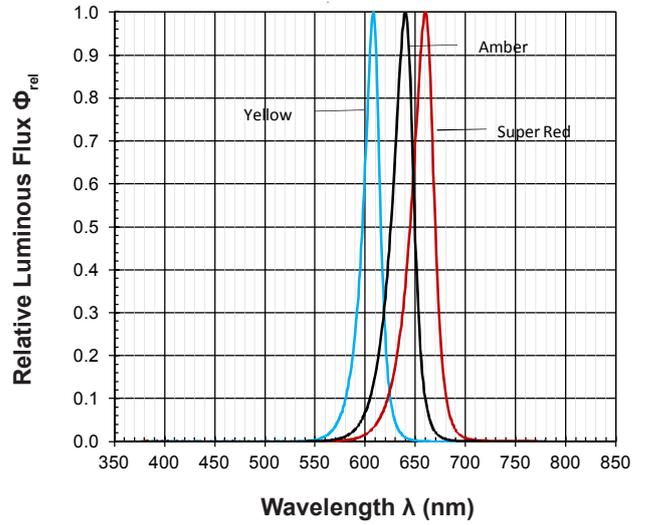
Maximum Current Vs Temperature

$I_F = f(T)$



Relative Spectral Emission

$\Phi_{rel} = f(\lambda); T_j = 25^\circ\text{C}; I_F = 350\text{mA}$

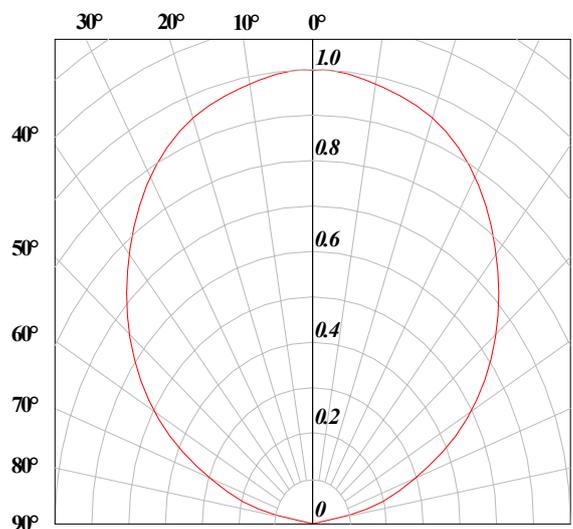


Allowable Forward Current Vs Duty Ratio

$(T_j = 25^\circ\text{C}; t_p \leq 10\mu\text{s})$

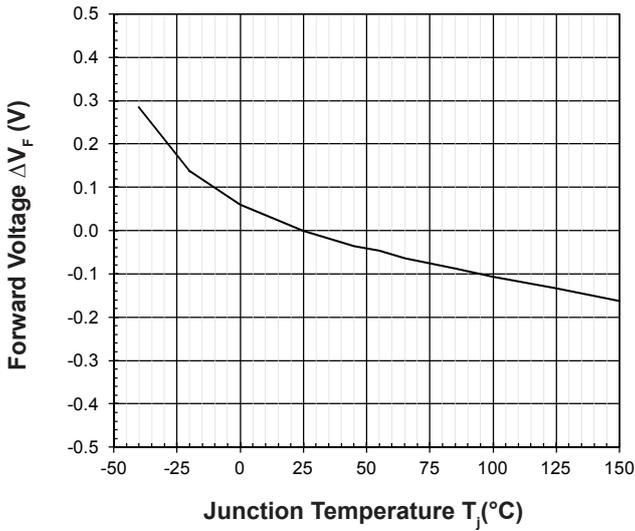


Radiation Pattern



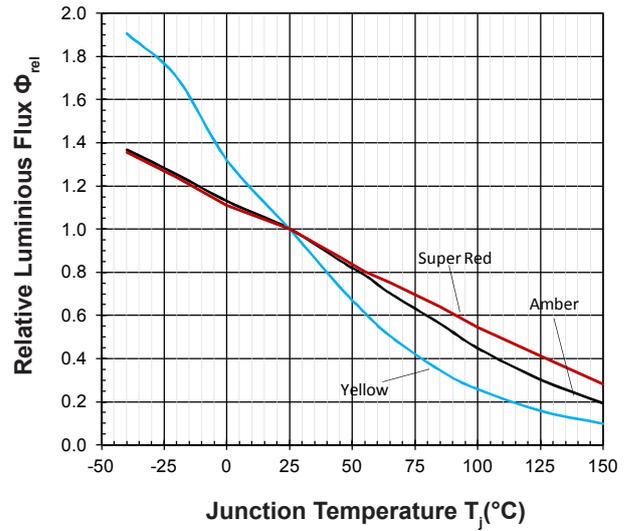
Forward Voltage Vs Junction Temperature

$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 350\text{mA}$$



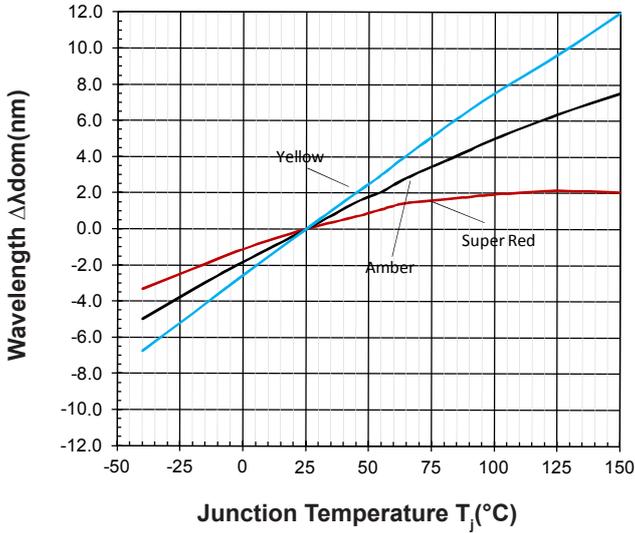
Relative Luminous Flux Vs Junction Temperature

$$\Phi_V/\Phi_V(25^\circ\text{C}) = f(T_j); I_F = 350\text{mA}$$

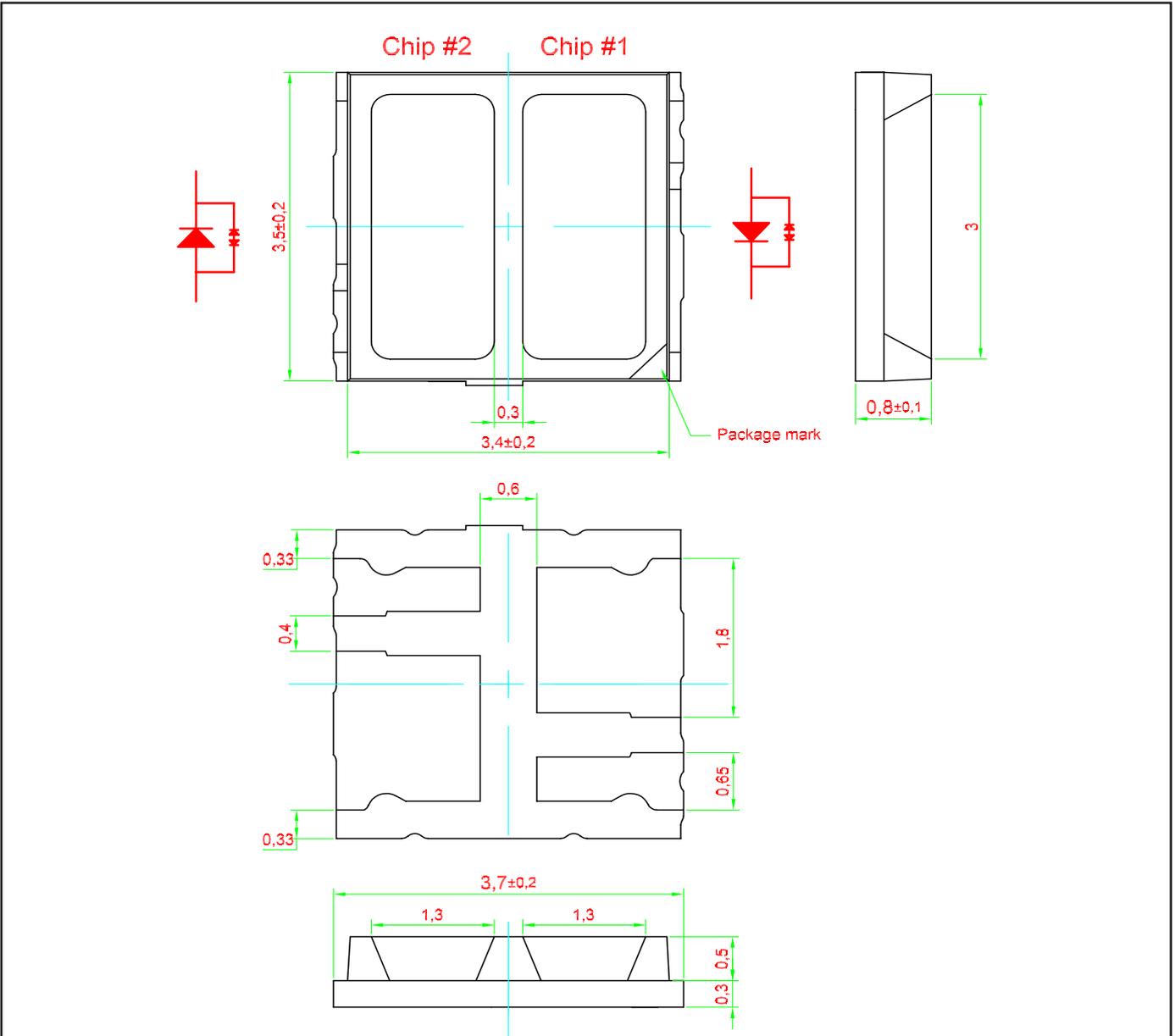


Wavelength Vs Junction Temperature

$$\Delta \lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}}(25^\circ\text{C}) = f(T_j); I_F = 350\text{mA}$$



PrimaxPlus Bi-Color • AllnGaP: MCxx-TZHG Package Outlines

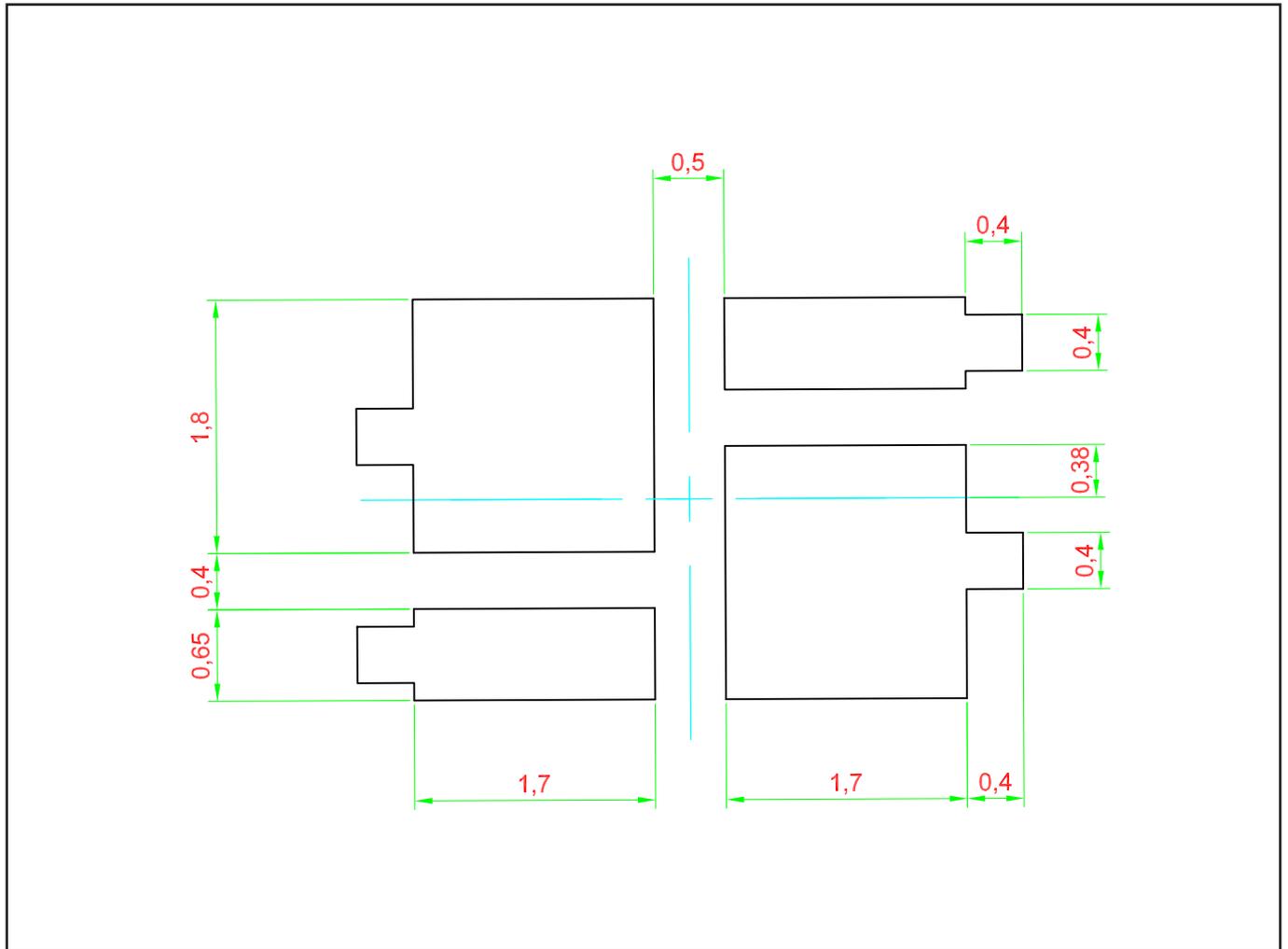


Notes:
 Primary thermal path is through Cathode lead of LED package.
 General tolerance: +/- 0.1mm.

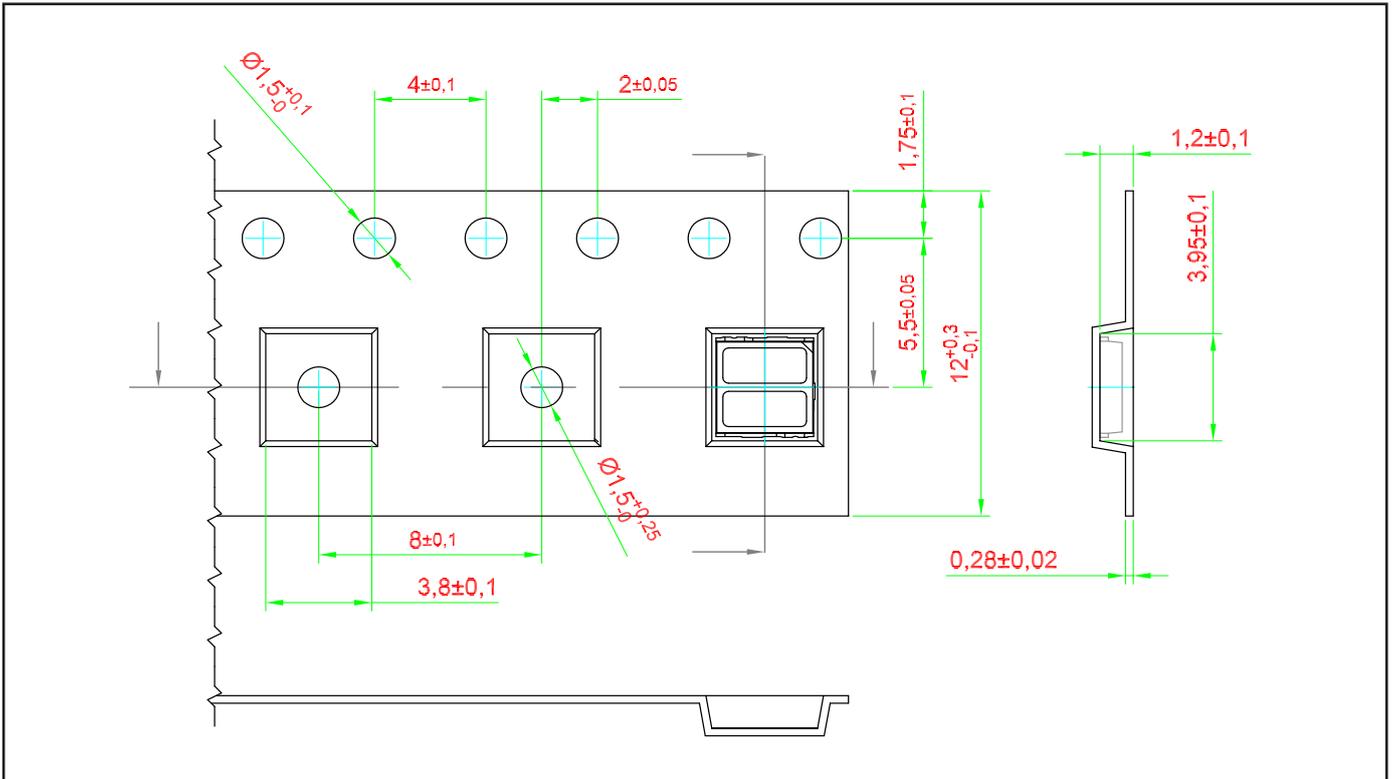
Material

	Material
Lead-frame	Cu Alloy With Au Plating
Package	High Temperature Resistant Plastic
Encapsulant	Silicone Resin
Soldering Leads	Au Plating

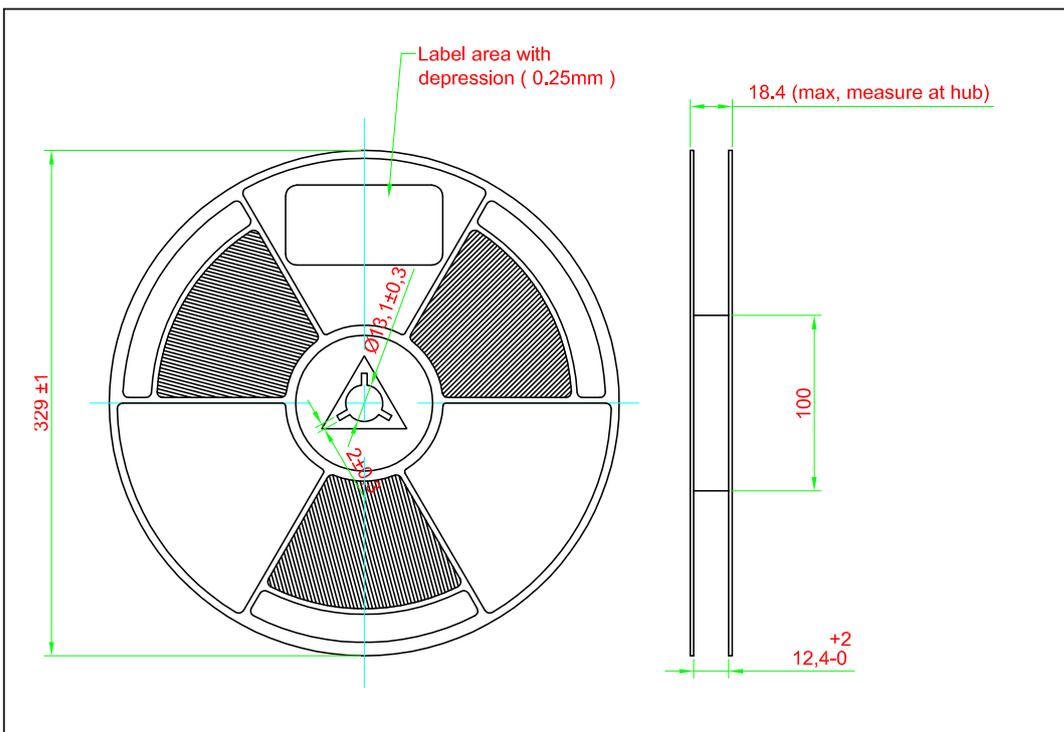
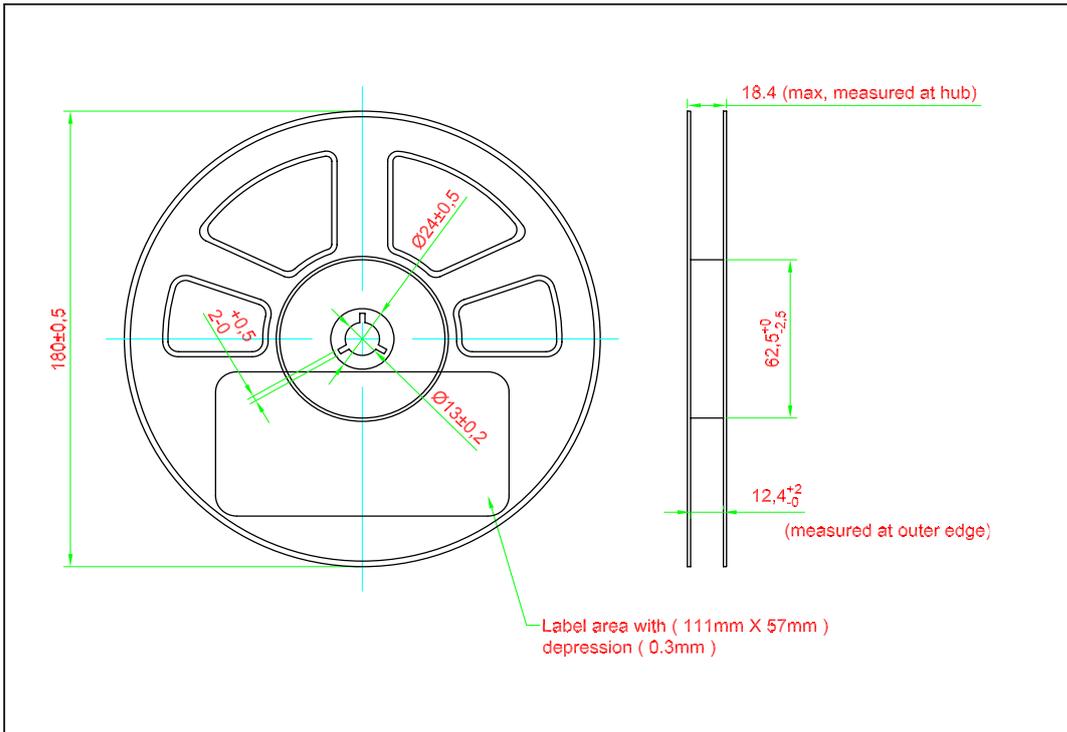
Recommended Solder Pad



Taping and orientation



Packaging Specification

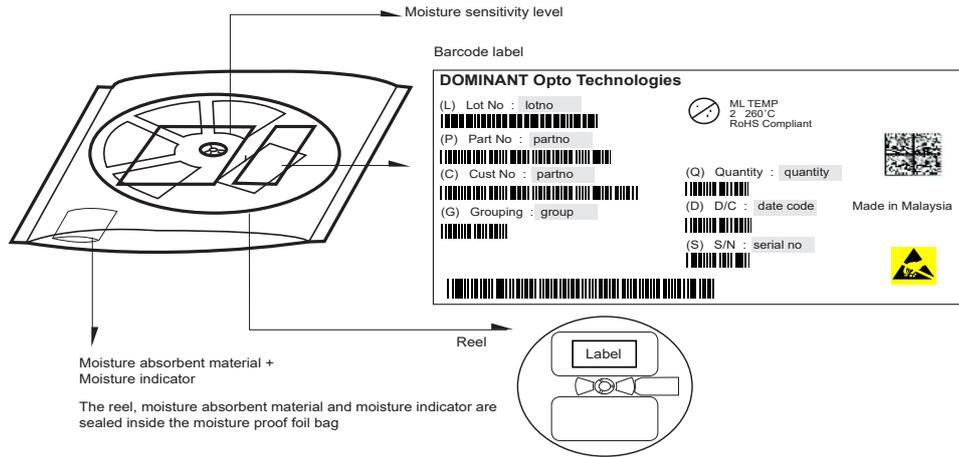


	Reel Diameter (mm)	Quantity (pcs)	*Ordering Number
Standard Packing	180	1500	MCxx-TZHG-xxx+xxx-x+x
Optional Packing	329	5000	MCxx-TZHG-xxx+xxx-x+x-5

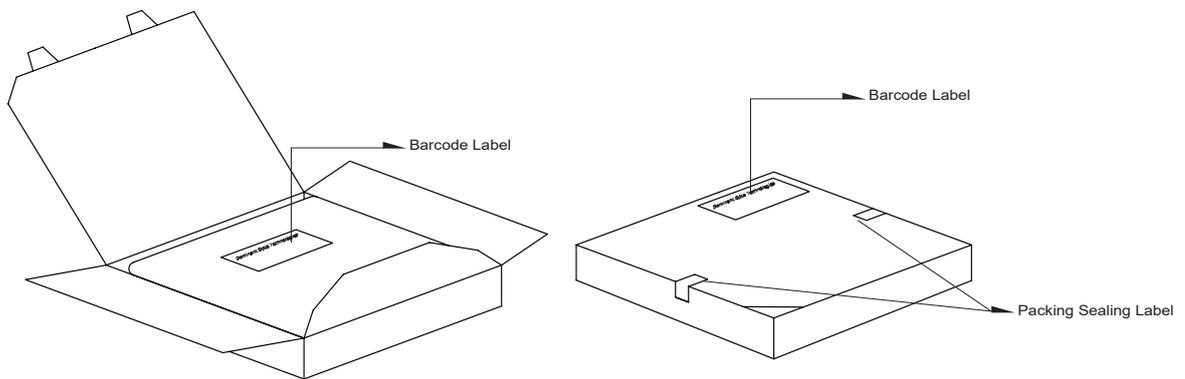
Notes:

* For ordering purpose only. Please consult sales and marketing for details.

Packaging Specification



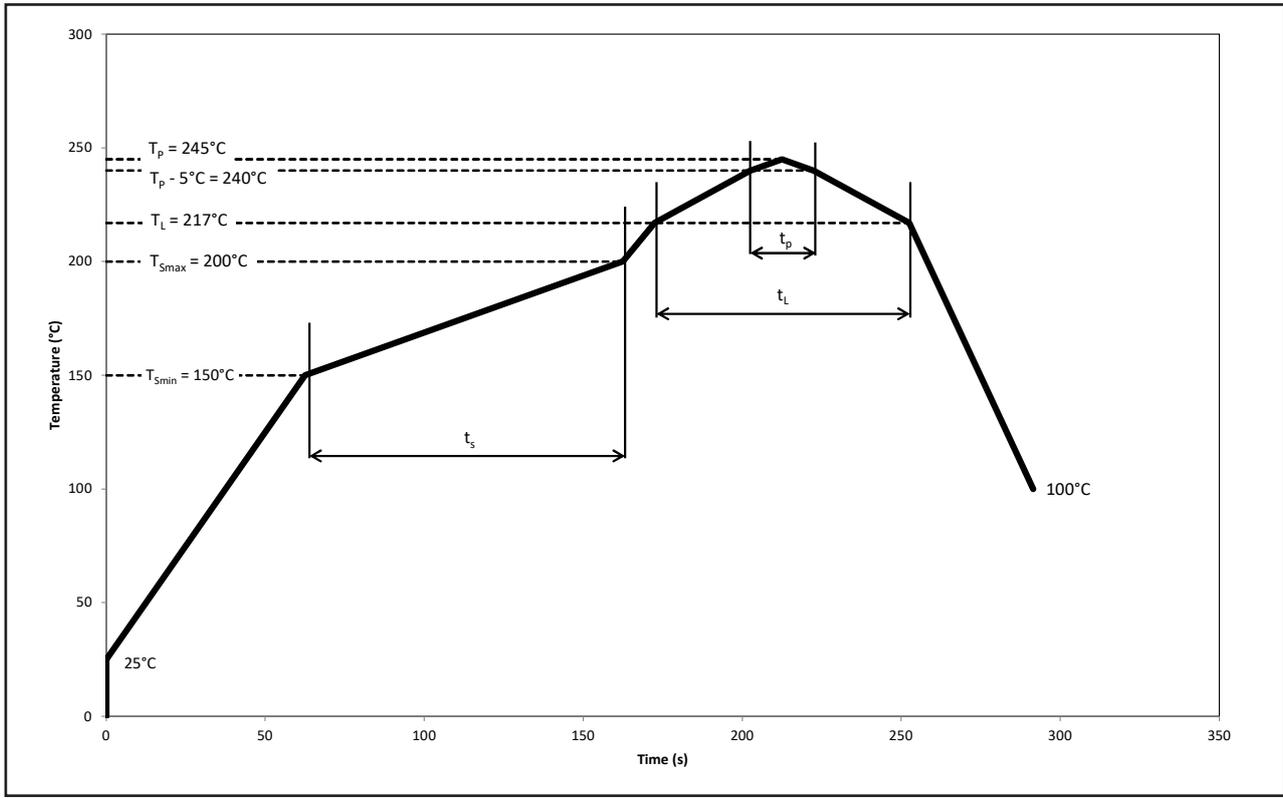
Quantity per bag (pcs)	Average 1pc PrimaxPlus (g)	1 completed bag (g)
1500	0.034	245 ± 10
5000	0.034	1150 ± 10



Reel Diameter (mm)	Packing Box Dimensions (mm)
180	210 x 210 x 20
329	345 x 345 x 20

Recommended Pb-free Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Pb-Free Assembly			Unit
		Min.	Recommended	Max.	
Ramp-up rate to preheat 25°C to T_{smin}	-	-	2	3	°C/s
Time t_s T_{smin} to T_{smax}	t_s	60	100	120	s
Ramp-up rate to peak T_L to T_p	-	-	2	3	°C/s
Liquidous temperature	T_L	-	217	-	°C
Time above liquidous temperature	t_L	60	80	150	s
Peak temperature	T_p	-	245	260	°C
Time within 5°C of the specified peak temperature $T_p - 5^\circ\text{C}$	t_p	10	20	30	s
Ramp-down rate T_p to 100°C	-	-	3	6	°C/s
Time 25°C to T_p	-	-	-	480	s

Appendix

1) **Brightness:**

- 1.1 Luminous intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of $k=3$).
- 1.2 Luminous flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of $k=3$).
- 1.3 Radiant intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of $k=3$).
- 1.4 Radiant flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of $k=3$).

2) **Color:**

- 2.1 Chromaticity coordinate groups are measured at current pulse 25 ms(typ) with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (accordingly to GUM with a coverage factor of $k=3$).
- 2.2 Dominant wavelength is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 0.5\text{nm}$ and an expanded uncertainty of $\pm 1\text{nm}$ (accordingly to GUM with a coverage factor of $k=3$).

3) **Voltage:**

- 3.1 Forward Voltage, V_f is measured when a current pulse of 8 ms(typ) with an internal reproducibility of $\pm 0.05\text{V}$ and an expanded uncertainty of $\pm 0.1\text{V}$ (accordingly to GUM with a coverage factor of $k=3$).

4) **Typical Values:**

- 4.1 At special conditions of LED manufacturing processes, typical data or calculated correlations of technical parameters only reflect the statistical figures. But not necessarily correspond to the actual parameters of each single product, which could differ from the typical data or calculated correlations or the typical characteristic line. These typical data may change whenever technical improvements happen.

5) **Tolerance of Measure**

- 5.1 Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimension are specific in mm.

Revision History

Page	Subjects	Date of Modification
-	Initial Release	28 Jun 2018
2, 6, 7, 8	Update partno: MCSS-TZHG-P3R2+P3R2-3+3 ->MCSS-TZHG-QR3+QR3-3+3 MCAA-TZHG-Q3S2+Q3S2-4+4 ->MCAA-TZHG-RT2+RT2-4+4 Typo Error: MCAY-TZHG-Q3S2+Q3S-4+1 -> MCAY-TZHG-RT2+Q3S-4+1 Update Package Outline Update Recommended Solder Pad Update Taping and Orientation	26 Oct 2018
1, 2, 6	Update Features Update Thermal resistance Typo Error on Package Outline	10 Jan 2019
6	Update Package Outline	19 Mar 2019
9, 10, 11	Update Packaging Specification Update Recommended Pb-free Soldering Profile	21 Mar 2022
9, 10	Update Quantity per Reel: 1000pcs to 1500pcs	14 Nov 2023

NOTE

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